SpecTek® Buyers Guides Last Revision: April 23, 2024

©2018 Micron Technology, Inc. All rights reserved. Information, products, and/or specifications are subject to change without notice. All information is provided on an "AS IS" basis without warranties of any kind. Statements regarding products, including regarding their features, availability, functionality, or compatibility, are provided for informational purposes only and do not modify the warranty, if any, applicable to any product. Drawings may not be to scale. Micron, the Micron logo, and all other Micron trademarks are the property of Micron Technology, Inc. All other trademarks are the property of their respective owners.



Micron Confidential

SpecTek Buyers Guide >> NAND

Grade	Product Type	Yield	Customer Application	RMA Policy	Technical Notes	Web Links
AS	Package	~ 97%	PCIe/SATA Consumer SSDs, USB/SD	YES – 90 Days Warranty < 1,000pcs RMAs NOT Accepted	 Datasheet Support. Use Factory Marked Blocks Sample MPN: FBNN48R4T1KLMAEJ4-AS 	<u>RMA Rapid</u> <u>Response</u> NAND
PG	Package	~ 45% (140s only) ~ 70% (150s & Newer)	SATA Consumer SSDs, USB/ SD	NO RMA: will only review cases if yield loss is significant	 NVB Not Guaranteed. Sorting Needed No Datasheet, Single/double plane firmware recommended Sample MPN: FBMB27A8T0KTWAFM5-PG 	Component/Die/W afer Part Number Guide
UT	Package	~ 80%	PCIe/SATA Consumer SSDs, USB/SD	NO RMA: will only review cases if yield loss is significant	 NVB Not Guaranteed. Sorting Needed No Datasheet Sample MPN: FBMB47R8T0KLWAEM5-UT 	Online Decoder Device Markings
E0	Uncut Wafer	~ 95%	PCIe/SATA Consumer SSDs, USB/SD, Mobile	NO RMA on Wafer/Die	 Datasheet Support. Use Factory Marked Blocks Wafer Maps and Bonding Diagram available Sample MPN: WCVM60ANNNXAA-NA<u>E0</u>A 	SpecTek Datasheets Roadmap
<u>E8</u>	Cut Die on Reconstructed Wafer	~ 80%	PCIe/SATA Consumer SSDs, USB/SD	NO RMA on Wafer/Die	 Bonding Diagram Only. Sorting Needed Sample MPN: W1UB47RDUNXNZ-NA<u>E8</u>U 	Questions / <u>Feedback</u>
<u>E5</u>	Cut Die on Reconstructed Wafer	~ 50%	Consumer SATA SSDs, USB/SD	NO RMA on Wafer/Die	 Bonding Diagram Only. Sorting Needed Sample MPN: W3UB47RDUNXNZ-NA<u>E5</u>U 	
<u>E4</u>	Cut Die on Reconstructed Wafer	~ 40%	Consumer SATA SSDs, USB/SD	NO RMA on Wafer/Die	 Bonding Diagram Only. Sorting Needed Sample MPN: WVUB16ADUNXNZ-NA<u>E4</u>U 	
<u>EX</u>	Carcass Die	N/A	N/A	NO RMA on Wafer/Die	 Die Left on blue tape after all Micron and SpecTek die picked Sample MPN: WBUL84DDBNXNZ-NA<u>EX</u>A 	

General Support Notes (READ):

> Yield estimates are averaged and may vary lot to lot. Yields also influenced by controllers and firmware capabilities and validated on limited number of common controllers.

> Data stored on the media prior to IR Reflow could damage the cell structure and reduce the Program/Erase cycles significantly. It is recommended that all blocks be in the erased state prior to IR Reflow.

> Cosmetic Defects are not covered under SpecTek RMA Policy. All RMAs **must** be returned in either the original packaging or an ESD safe container(trays, tape and reel) or the RMA may be rejected.

> Consumer SSDs: SSDs with Non-Binary Densities such as 240GB, 480GB, 960GB.



Micron Confidential

SpecTek Buyers Guide >> NAND >> Approved Controller List

Consumer SSDs	Controllers	B58R	N48R	B47R	B47T
	SM2263XT		\checkmark	\checkmark	
PCle Gen 3	MAP1202A			\checkmark	\checkmark
	RTS5766DL	\checkmark	\checkmark	\checkmark	\checkmark
	SM2259XT(2)	\checkmark	\checkmark	\checkmark	\checkmark
SATA	MAS1102B	\checkmark	\checkmark	\checkmark	\checkmark
	RTS5735DL	\checkmark	\checkmark	\checkmark	\checkmark
	SM3265			\checkmark	\checkmark
USB 3.x	AU89103	\checkmark	\checkmark	\checkmark	\checkmark
	IS918M		\checkmark	\checkmark	
USB 2.x	AU6998		\checkmark		\checkmark
SD	AK2705EN			\checkmark	

Notes:

 \checkmark = Controller and DID compatibility internally verified

3 Micron Confidential



SpecTek Buyers Guide >> DRAM

Grade	Product Type	Yield ¹	Customer Application	RMA Policy	Technical Notes	Web Links
PRN / PRM	Package	~ 99%	UDIMM, SODIMM CUDIMM / CSODIMM Module	 90 Days Warranty Minimal RMA QTY: 1000 Units 	 Fully Tested & Speed Graded Datasheet Support Component Testing Not Required Sample MPN: PRN1G16Z22AD8RC-062E 	RMA Rapid Response Motherboard Compatibility List
PRN / PRM <mark>OC</mark>	Package	N/A	OC UDIMM	 90 Days Warranty (JEDEC Timings Only) Minimal RMA QTY: 1000 Units 	 Fully Tested & Speed Graded Datasheet Support: Refer to JEDEC datasheet Component Testing Recommended ⁴ Sample MPN: PRM2G8Y52KBFRZ-56B 	DRAM Component Part Numbering Guide Online MPN Decoder
ТР	Package	~ 90%	UDIMM / CUDIMM 8-Chip Module	 90 Days Warranty Minimal RMA QTY: 1000 Units 	 Datasheet Support (Reference PRN Datasheet) Component Testing Recommended ² Sample MPN: SUU512M16Z11BD8LY-TP 	DRAM Component Mark <u>Reference</u> Laser Mark to MPN
ХСВ	Module	~ 75%	UDIMM / CUDIMM Module	• No RMA: will only review cases if yield loss is significant	 Components on module No Datasheet Component Testing Recommended ² Sample MPN: XCB 512M8V00HG8DA-MSPD 	<u>Decoder</u> <u>SpecTek Datasheets</u> <u>Roadmaps</u>
ХСВВ	Module	~ 75%	UDIMM / CUDIMM Module	No RMA: will only review cases if yield loss is significant	 Components on module, reconfigured to 8 bits No Datasheet Component Testing Recommended ² Sample MPN: XCBB512M8V00HG8DA-MSPD 	Questions / Feedback
PG	Package	~ 50%	UDIMM / CUDIMM Module	No RMA: will only review cases if yield loss is significant	 Partially Good components No Datasheet Component Testing Required ³ Sample MPN: SUM1G16Z22AD8RC-PG 	

General Support Notes (READ):

> Yield ¹: Based on MemTest test software.

> Testing Recommended ²: Component testing is recommended prior to assembly.

> Testing Required ³: Customer **must** test the product before assembly.

> Cosmetic Defects are not covered under RMA Policy. All RMAs must be returned in either the original packaging or an ESD safe container(trays, tape and reel) or the RMA may be rejected.

> Testing Recommended ⁴ for OC timings above JEDEC rated timings



Micron Confidential

SpecTek Buyers Guide >> Low Power DRAM & MCPs

Grade	Product Type	Yield	RMA Policy	Technical Notes	Web Links
BT	Package	~ 85% - 95%	 No RMA: will only review cases if yield loss is significant 	 Testing Required. Yield is dependent on application & chipsets May also be referred to as "2P Packages" Datasheet Support Sample MPN: SN512M32Z42MD1DNQ-053BT 	RMA Rapid Response Mobile DRAM Part Numbering <u>Guide</u>
UT	Package	~ 80%	No RMA: will only review cases if yield loss is significant	 Testing Required No Datasheet Sample MPN: SM2G64Z32MD8DTN-UT 	All-in-One Part Numbering Guide eMMC Part Numbering Guide
PG	Package	~ 50%	No RMA: will only review cases if yield loss is significant	 Testing Required No Datasheet Sample MPN: SM512M32Z42MD1DNQ-PG 	NAND MCP Part Numbering <u>Guide</u>
P2	Uncut Wafer	~ 99%	NO RMA on Wafer/Die	 Wafer Maps and Bonding Diagram Support Sample MPN: WJ3Z0AMNNAF-<u>P2E0</u>D 	 <u>LPDRAM Wafer/Die Part</u> <u>Numbering Guide</u> <u>Online Decoder</u> SpecTek Datasheets
FP	Cut Die on Reconstructed Wafer	~ 97%	NO RMA on Wafer/Die	 Fully tested good die May also be referred to as "1P dies" Bonding Diagram Support Only Sample MPN: WBFV01MDHAHP-<u>FPE0</u>D 	 <u>Roadmaps</u> <u>Questions / Feedback</u>
4P	Half Density Cut Die on Reconstructed Wafer	~ 98%	NO RMA on Wafer/Die	 Fully tested Half-Density good die Bonding Diagram Support Only Sample MPN: WBXV01MDHABP-<u>4PE0</u>D 	

General Support Notes (READ):

> Target Application: Low-End to Mid Range Tablets, Low-End Mobile Phones, IOT, OTT/STB applications

> Cosmetic Defects are not covered under RMA Policy. All RMAs must be returned in either the original packaging or an ESD safe container(trays, tape and reel) or the RMA may be rejected.

